

C1805C223K5RACTU

Aliases (C1805C223K5RAC7800) SMD Comm X7R, Ceramic, 0.022 uF, 10%, 50 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 1805, 2.9 mm



Click here for the 3D model.

| General Information | |
|--------------------------|--|
| Series | SMD Comm X7R |
| Style | SMD Chip |
| Description | SMD, MLCC, Temperature Stable, Class II |
| Features | Temperature Stable, Class II |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 41 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Specifications | |
|--|--|
| Capacitance | 0.022 uF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Tolerance | 10% |
| Voltage DC | 50 VDC |
| Dielectric Withstanding Voltage | 125 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | X7R |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms |
| Dissipation Factor | 2.5%1kHz1.0Vrms |
| Aging Rate | 3% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 45.4545 GOhms |

 Dimensions

 Chip Size
 1805

 L
 4.5mm +/-0.5mm

 W
 1.27mm +/-0.38mm

 T
 0.9mm +/-0.10mm

 S
 2.9mm MIN

 B
 0.6mm +/-0.35mm

Packaging Specifications

| Packaging | T&R, 180mm, Plastic Tape |
|--------------------|--------------------------|
| Packaging Quantity | 4000 |

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